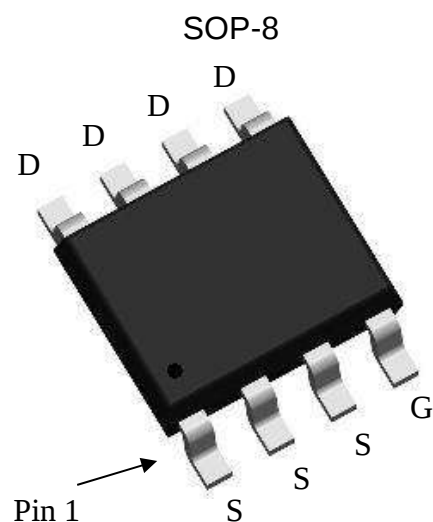


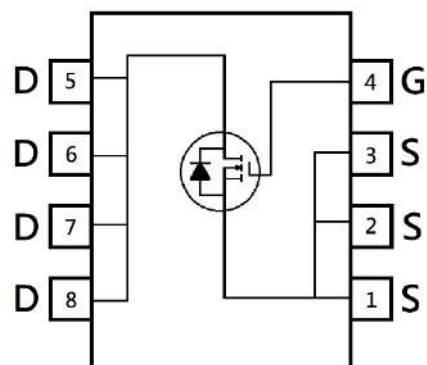
## N-Channel Enhancement Mode Power MOSFET

### Features:

- Low On Resistance
- Single Drive Requirement
- Low On-resistance
- Fast Switching Characteristic
- RoHS compliant package



|                                   |               |
|-----------------------------------|---------------|
| $BV_{DSS}$                        | 60V           |
| $I_D@V_{GS}=10V, T_C=25^\circ C$  | 28A           |
| $I_D@V_{GS}=10V, T_A=25^\circ C$  | 12A           |
| $R_{DS(ON)}@V_{GS}=10V, I_D=12A$  | 5.6m $\Omega$ |
| $R_{DS(ON)}@V_{GS}=4.5V, I_D=12A$ | 10m $\Omega$  |



G : Gate S : Source D : Drain

### Ordering Information

| Device      | Package                                          | Shipping               |
|-------------|--------------------------------------------------|------------------------|
| KSCB7D0N06R | SOP-8<br>(RoHS compliant & Halogen-free package) | 4000 pcs / Tape & Reel |

## Absolute Maximum Ratings (T<sub>A</sub>=25°C)

| Parameter                                                              | Symbol                            | Limits   | Unit |
|------------------------------------------------------------------------|-----------------------------------|----------|------|
| Drain-Source Voltage                                                   | V <sub>DS</sub>                   | 60       | V    |
| Gate-Source Voltage                                                    | V <sub>GS</sub>                   | ±20      |      |
| Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>C</sub> =25°C  | I <sub>D</sub>                    | 28       | A    |
| Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>C</sub> =100°C |                                   | 17.7     |      |
| Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>A</sub> =25°C  |                                   | 12       |      |
| Continuous Drain Current @ V <sub>GS</sub> =10V, T <sub>A</sub> =70°C  |                                   | 9.6      |      |
| Pulsed Drain Current                                                   | I <sub>DM</sub>                   | 56       |      |
| Continuous Body Diode Forward Current @ T <sub>A</sub> =25°C           | I <sub>S</sub>                    | 10       |      |
| Pulsed Body Diode Forward Current @ T <sub>A</sub> =25°C               | I <sub>SM</sub>                   | 40       |      |
| Avalanche Current @ L=0.1mH                                            | I <sub>AS</sub>                   | 25       |      |
| Avalanche Energy @ L=0.5mH                                             | E <sub>AS</sub>                   | 56       | mJ   |
| Total Power Dissipation                                                | T <sub>A</sub> =25°C              | 12.5     | W    |
|                                                                        | T <sub>A</sub> =100°C             | 5        |      |
|                                                                        | T <sub>A</sub> =25°C              | 2.3      |      |
|                                                                        | T <sub>A</sub> =70°C              | 1.5      |      |
| Operating Junction and Storage Temperature Range                       | T <sub>J</sub> , T <sub>stg</sub> | -55~+150 | °C   |

## Thermal Data

| Parameter                               | Symbol           | Steady State | Unit |
|-----------------------------------------|------------------|--------------|------|
| Thermal Resistance, Junction-to-case    | R <sub>θJC</sub> | 10           | °C/W |
| Thermal Resistance, Junction-to-ambient | R <sub>θJA</sub> | 55           |      |

Note:

- \*a. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- \*b. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2 oz. copper, in a still air environment with T<sub>A</sub>=25°C. The power dissipation P<sub>DSM</sub> is based on R<sub>θJA</sub> and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- \*c. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150°C. Ratings are based on low frequency and low duty cycles to keep initial T<sub>J</sub>=25°C.

**Characteristics (T<sub>A</sub>=25°C, unless otherwise specified)**

| Symbol                    | Min. | Typ. | Max. | Unit | Test Conditions                                                                      |
|---------------------------|------|------|------|------|--------------------------------------------------------------------------------------|
| Static                    |      |      |      |      |                                                                                      |
| BV <sub>DSS</sub>         | 60   | -    | -    | V    | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                           |
| V <sub>GS(th)</sub>       | 1    | -    | 2.5  |      | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                             |
| G <sub>FS</sub>           | -    | 16   | -    | S    | V <sub>DS</sub> =10V, I <sub>D</sub> =10A                                            |
| I <sub>GSS</sub>          | -    | -    | ±100 | nA   | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                           |
| I <sub>DSS</sub>          | -    | -    | 1    | μA   | V <sub>DS</sub> =48V, V <sub>GS</sub> =0V                                            |
| R <sub>DS(ON)</sub>       | -    | 5.6  | 7.5  | mΩ   | V <sub>GS</sub> =10V, I <sub>D</sub> =12A                                            |
|                           | -    | 10   | 15   |      | V <sub>GS</sub> =4.5V, I <sub>D</sub> =12A                                           |
| Dynamic                   |      |      |      |      |                                                                                      |
| C <sub>iss</sub>          | -    | 2333 | -    | pF   | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz                                    |
| C <sub>oss</sub>          | -    | 338  | -    |      |                                                                                      |
| C <sub>rss</sub>          | -    | 37   | -    |      |                                                                                      |
| R <sub>g</sub>            | -    | 2    | -    | Ω    | f=1MHz                                                                               |
| Q <sub>g</sub> *1, 2      | -    | 37   | -    | nC   | V <sub>DS</sub> =48V, I <sub>D</sub> =12A, V <sub>GS</sub> =10V                      |
| Q <sub>gs</sub> *1, 2     | -    | 9    | -    |      |                                                                                      |
| Q <sub>gd</sub> *1, 2     | -    | 8    | -    |      |                                                                                      |
| t <sub>d(ON)</sub> *1, 2  | -    | 20   | -    | ns   | V <sub>DS</sub> =30V, I <sub>D</sub> =12A, V <sub>GS</sub> =10V, R <sub>GS</sub> =3Ω |
| t <sub>r</sub> *1, 2      | -    | 19   | -    |      |                                                                                      |
| t <sub>d(OFF)</sub> *1, 2 | -    | 62   | -    |      |                                                                                      |
| t <sub>f</sub> *1, 2      | -    | 13   | -    |      |                                                                                      |
| Source-Drain Diode        |      |      |      |      |                                                                                      |
| V <sub>SD</sub> *1        | -    | 0.8  | 1.2  | V    | I <sub>S</sub> =10A, V <sub>GS</sub> =0V                                             |
| t <sub>rr</sub>           | -    | 24   | -    | ns   | I <sub>F</sub> =10A, dI <sub>F</sub> /dt=100A/μs                                     |
| Q <sub>rr</sub>           | -    | 19   | -    | nC   |                                                                                      |

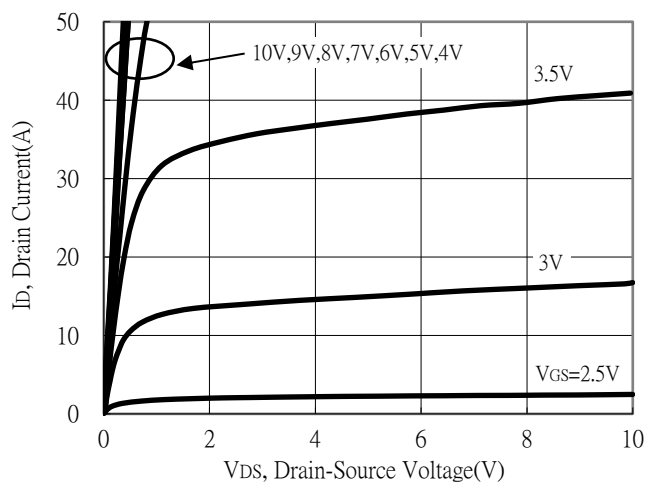
Note:

\*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

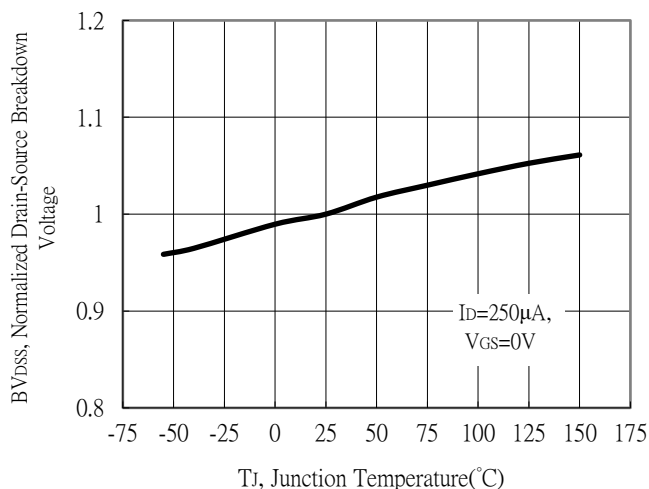
\*2. Independent of operating temperature

## Typical Characteristics

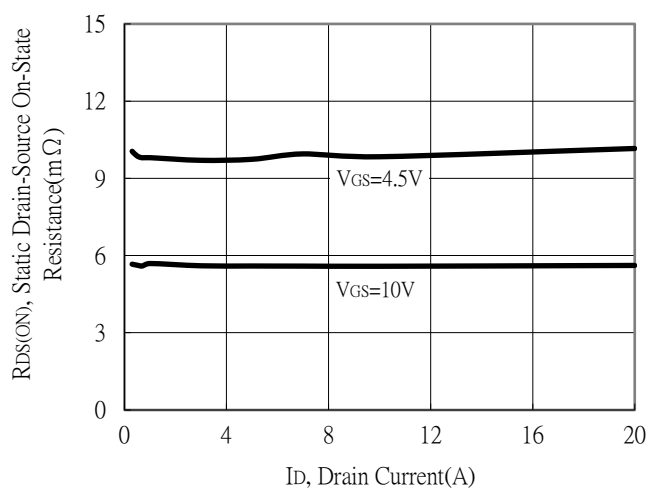
Typical Output Characteristics



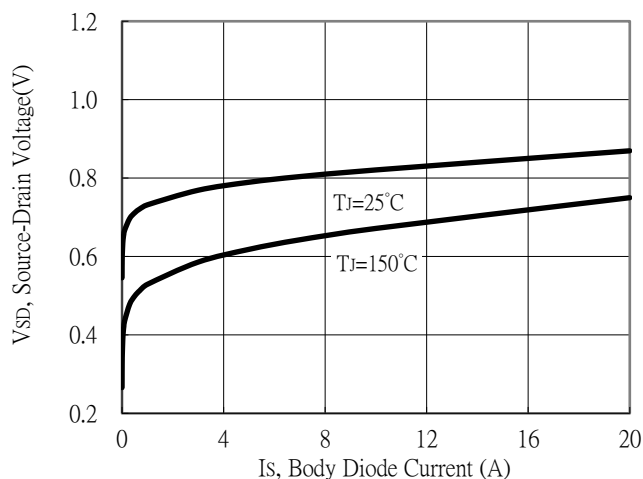
Breakdown Voltage vs Ambient Temperature



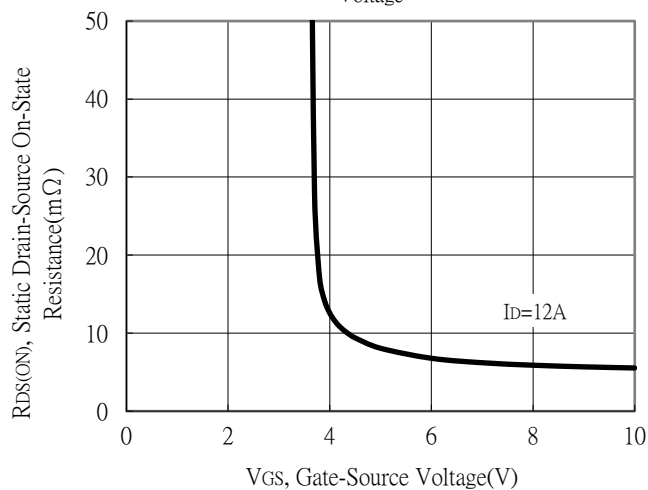
Static Drain-Source On-State resistance vs Drain Current



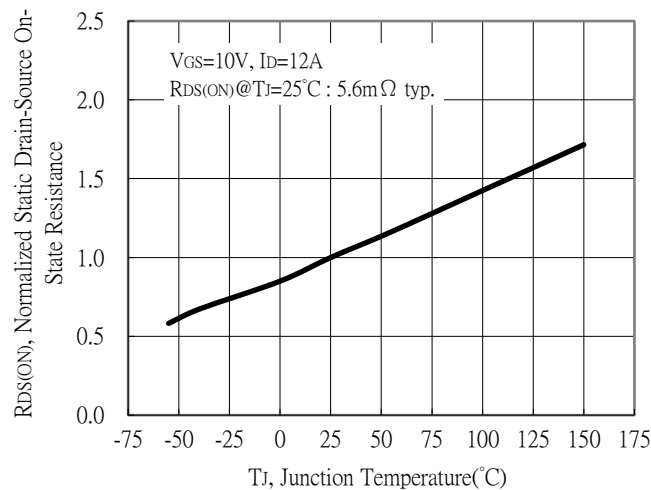
Body Diode Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

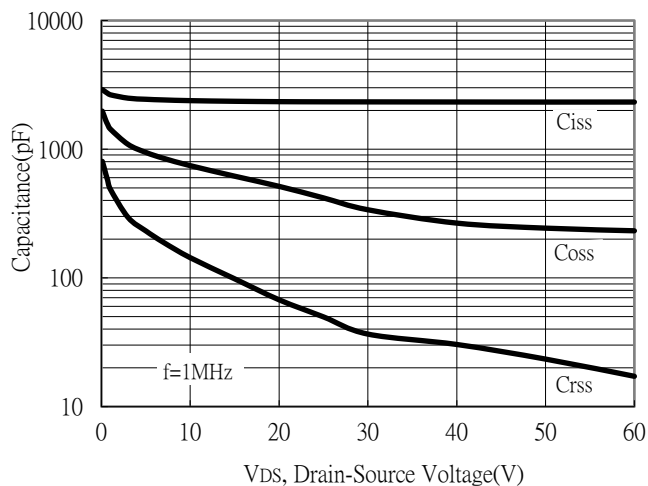


Drain-Source On-State Resistance vs Junction Temperature

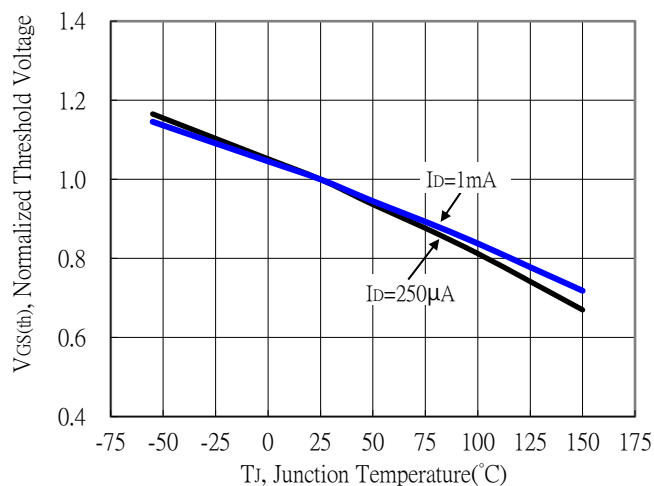


## Typical Characteristics (Cont.)

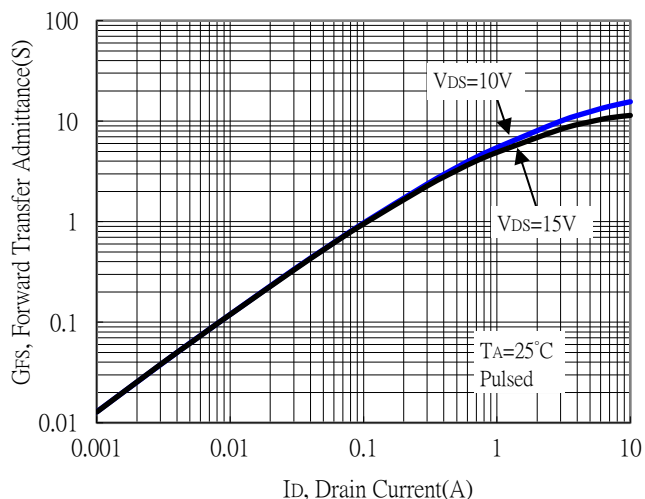
Capacitance vs Drain-to-Source Voltage



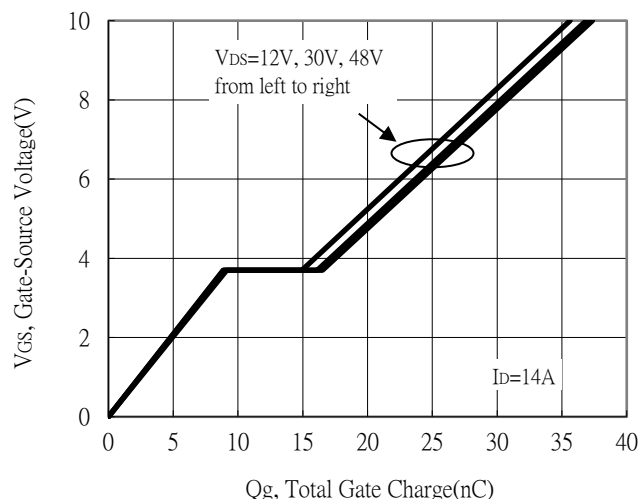
Threshold Voltage vs Junction Temperature



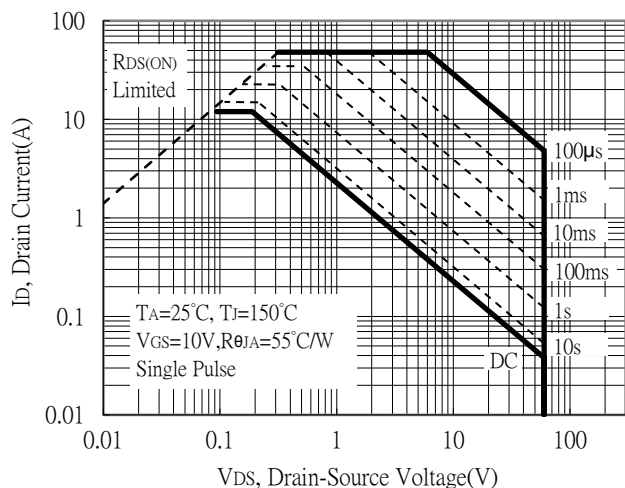
Forward Transfer Admittance vs Drain Current



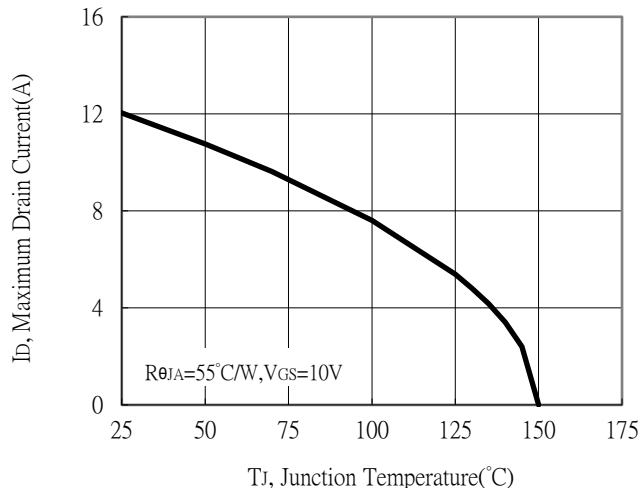
Gate Charge Characteristics



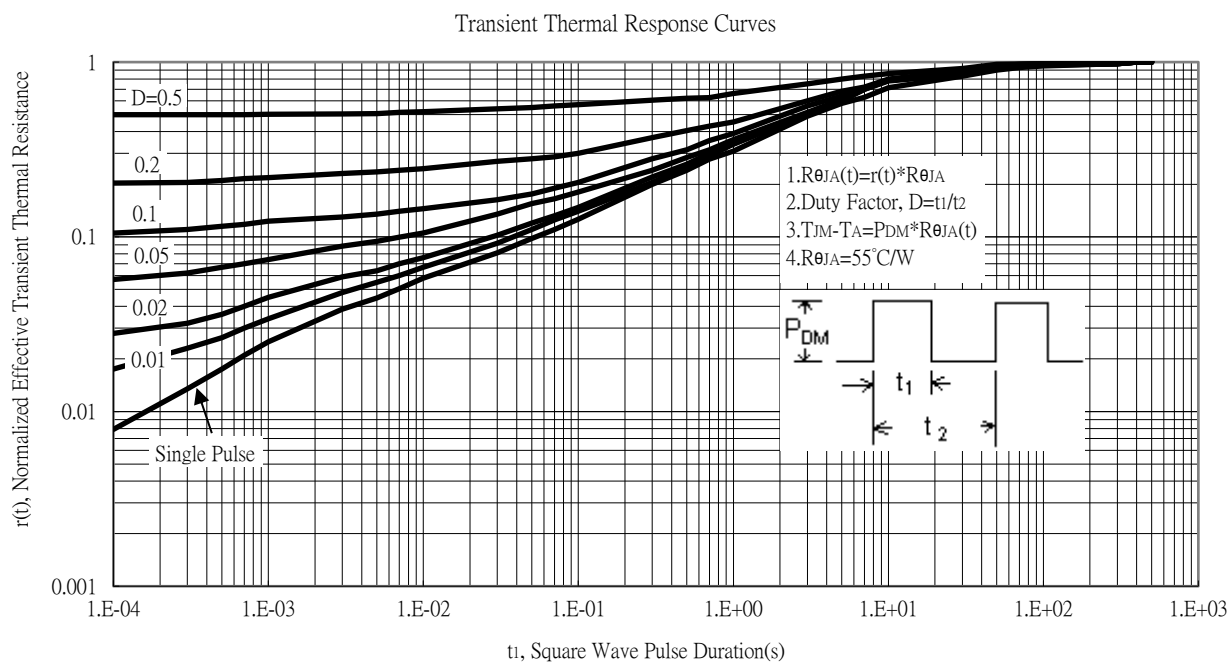
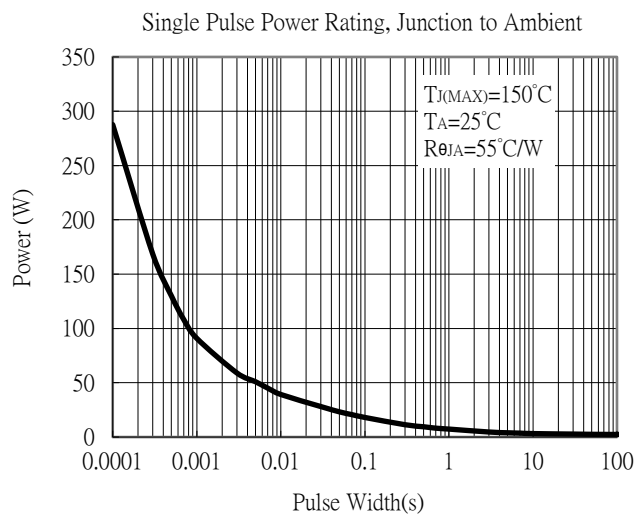
Maximum Safe Operating Area



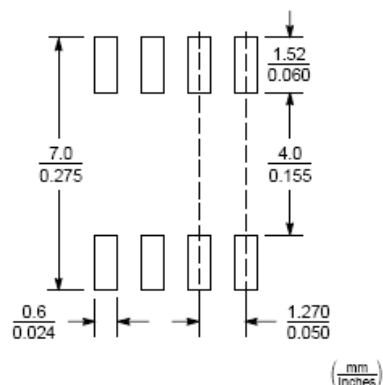
Maximum Drain Current vs Junction Temperature



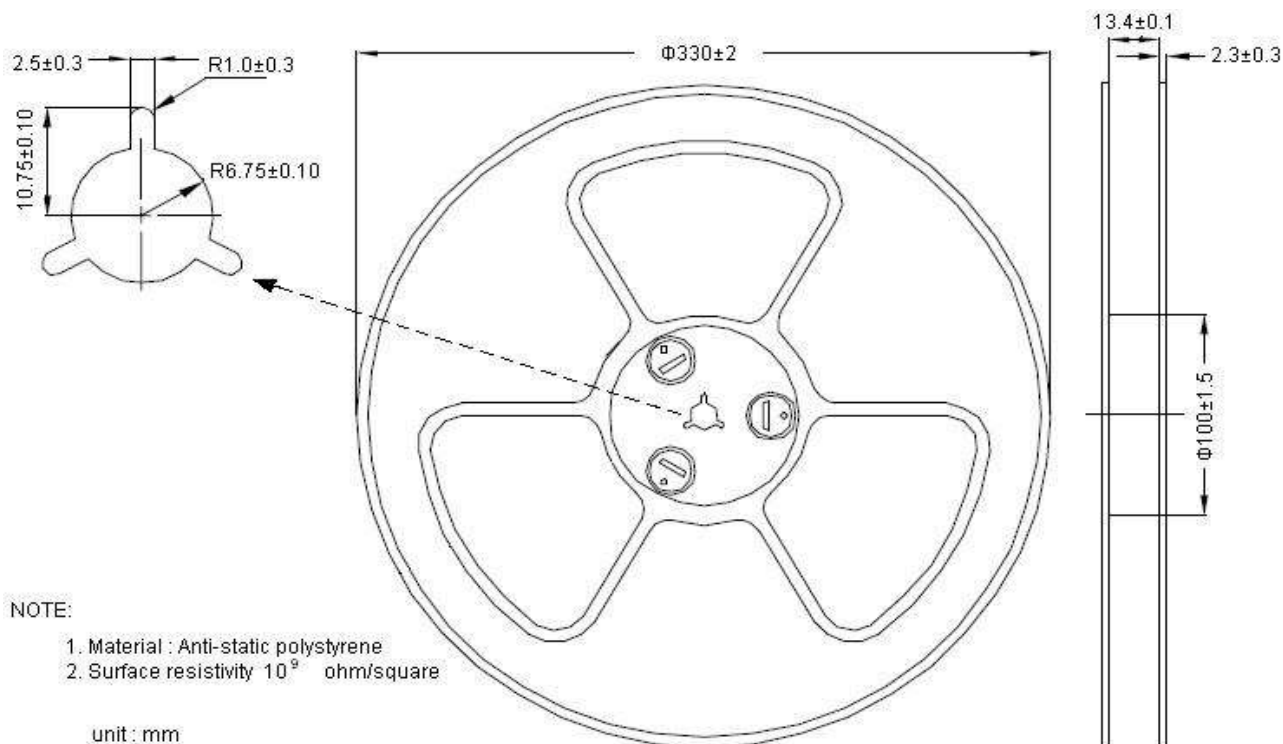
## Typical Characteristics (Cont.)



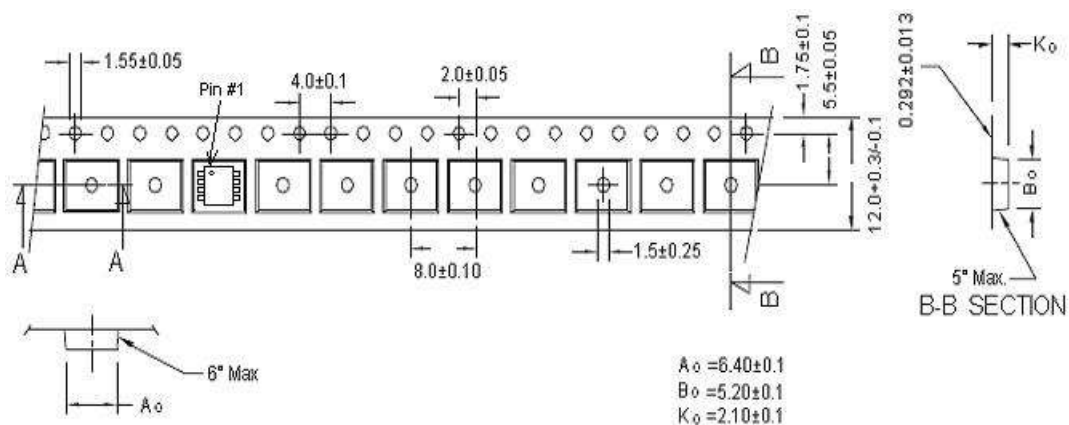
## Recommended Soldering Footprint



## Reel Dimension



## Carrier Tape Dimension

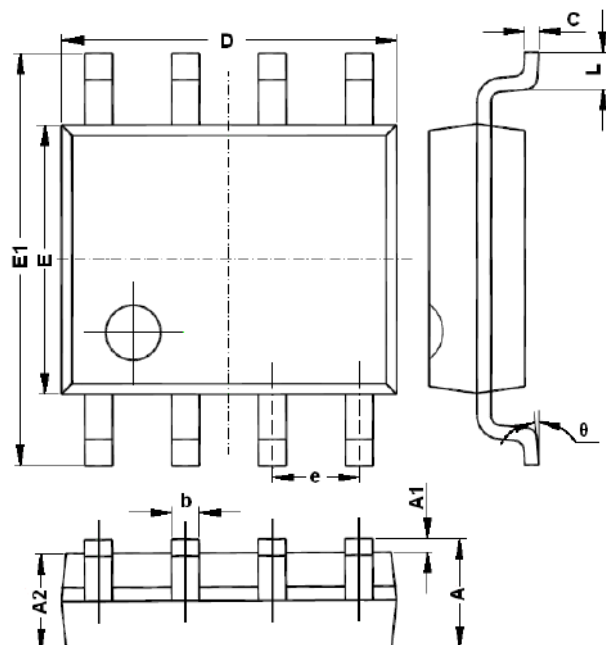


### Notes:

1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ .
2. Camber not to exceed 1mm in 100mm.
3. Material: conductive black polystyrene
4.  $A_0$  &  $B_0$  measured on a plane 0.3mm above the bottom of the pocket.
5.  $K_0$  measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

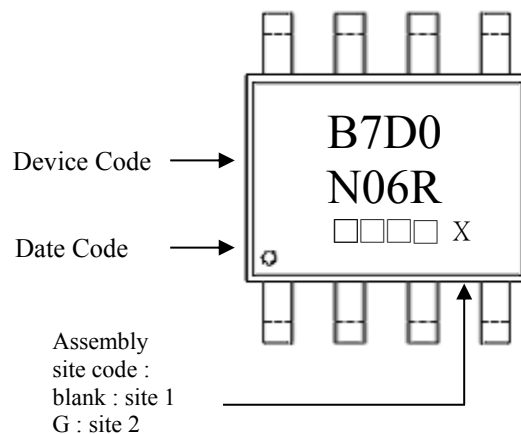
Unit : millimeter

## SOP-8 Dimension



8-Lead SOP-8 Plastic Package

### Marking:



Date Code(counting from left to right) :

1<sup>st</sup> code: year code, the last digit of Christian year

2<sup>nd</sup> code : month code, Jan→A, Feb→B, Mar→C, Apr→D

May→E, Jun→F, Jul→G, Aug→H, Sep→J,

Oct→K, Nov→L, Dec→M

3<sup>rd</sup> and 4<sup>th</sup> codes : production serial number, 01~99

| DIM | Millimeters |       | Inches |       | DIM | Millimeters |       | Inches |       |
|-----|-------------|-------|--------|-------|-----|-------------|-------|--------|-------|
|     | Min.        | Max.  | Min.   | Max.  |     | Min.        | Max.  | Min.   | Max.  |
| A   | 1.350       | 1.750 | 0.053  | 0.069 | E   | 3.800       | 4.200 | 0.150  | 0.165 |
| A1  | 0.100       | 0.250 | 0.004  | 0.010 | E1  | 5.800       | 6.200 | 0.228  | 0.244 |
| A2  | 1.350       | 1.550 | 0.053  | 0.061 | e   | 1.270       | (BSC) | 0.050  | (BSC) |
| b   | 0.330       | 0.510 | 0.013  | 0.020 | L   | 0.300       | 1.270 | 0.012  | 0.050 |
| c   | 0.170       | 0.250 | 0.006  | 0.010 | θ   | 0           | 8°    | 0      | 8°    |
| D   | 4.700       | 5.100 | 0.185  | 0.200 |     |             |       |        |       |